

Serial No. 10/774,440
February 16, 2006
Reply to the Office Action dated November 16, 2005
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AMENDMENTS TO THE SPECIFICATION

Please REPLACE the fourth full paragraph on page 5 of the Specification with the following amended paragraph:

The ceramic substrate 10 is preferably made by forming capacitor patterns, inductor patterns, and resistor patterns (none are shown) on ceramic green sheets, laminating these green sheets to define predetermined circuit elements, and then firing the green sheets. The incorporated circuit elements are electrically connected to each other by, for example, via holes. The ceramic substrate 10 has external ground electrodes 11 on its front and back surfaces and external electrodes 12 for input/output or grounding on its side surfaces, and accordingly the external electrodes 11, 12 are not disposed in the corners of the top surface of the ceramic substrate 10. The external electrodes are connected to the incorporated circuit elements.

Please REPLACE the first full paragraph on page 9 of the Specification with the following amended paragraph:

With reference to Fig. 4, in an integrated electronic component according to a second preferred embodiment, the substrate-facing segments 21c of the metal case 20 have notches 21f preferably having a substantially convex circular arc shape facing downward at the positions opposing the corners 10a of the top surface of the ceramic substrate 10. Other elements are identical to those in the above-described first preferred embodiment. The same reference numerals are used in Fig. 4 and Figs. 1 to 3 to identify the same elements and blocks, and duplicated descriptions are omitted.